

# N-Channel Power Trench<sup>®</sup> MOSFET 30 V, 16.9 A, 5.7 m $\Omega$

## Features

- Max  $r_{DS(on)} = 5.7 \text{ m}\Omega$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 16.9 \text{ A}$
- Max  $r_{DS(on)} = 7.0 \text{ m}\Omega$  at  $V_{GS} = 4.5 \text{ V}$ ,  $I_D = 15.0 \text{ A}$
- High performance technology for extremely low r<sub>DS(on)</sub>
- Termination is Lead-free and RoHS Compliant

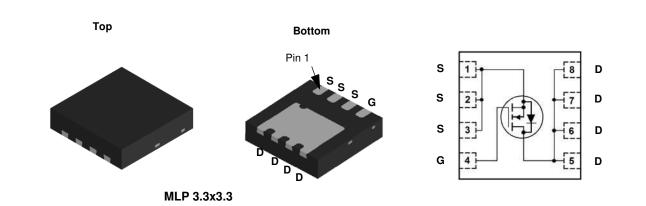


## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

### Application

- DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage		30	V		
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous	T <sub>C</sub> = 25 °C		20		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	16.9	Α	
	-Pulsed			50		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	144	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C	T <sub>C</sub> = 25 °C		w	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.3	VV	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.7	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	53	C/ VV

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC7672	FDMC7672	MLP 3.3x3.3	13 "	12 mm	3000 units

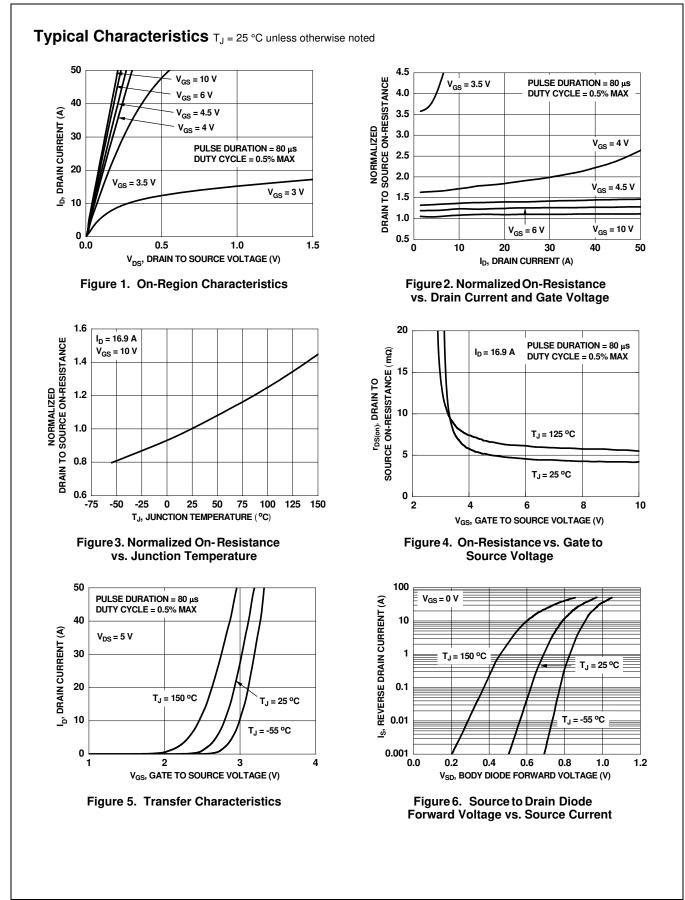
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{\rm D} = 250 \ \mu \text{A}, \ V_{\rm GS} = 0 \ \text{V}$				V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$ , referenced to 25 °C		13		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
		T <sub>J</sub> = 125 °C V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			250		
GSS	Gate to Source Leakage Current	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	1.2	1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-6		mV/°C	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 16.9 \text{ A}$		4.3	5.7		
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \ I_D = 15.0 \text{ A}$		5.4	7.0	mΩ	
DO(011)		$V_{GS} = 10 \text{ V}, I_D = 16.9 \text{ A}$ $T_J = 125 \text{ °C}$		5.5	6.9		
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = 5 V, I_D = 16.9 A$		82		S	
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ = 1 MHz		2925 1050 80	3890 1400 120	pF pF pF	
R <sub>q</sub>	Gate Resistance			0.9	2.7	Ω	
Switching t <sub>d(on)</sub>	Characteristics			13	24	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 16.9 A,		6	12	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		31	49	ns	
t <sub>f</sub>	Fall Time			5	10	ns	
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		40	57	nC	
	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V$ $I_{D} = 16.9 \text{ A}$		18	24	nC	
Q <sub>gs</sub>	Total Gate Charge Gate to Drain "Miller" Charge			9 4		nC nC	
Q <sub>gd</sub>				4		lic	
Drain-Sou	urce Diode Characteristics					1	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage			0.83 0.72	1.2 1.2	V	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 16.9 A, di/dt = 100 A/μs		39	62	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	$= 16.9 \text{ A}, \text{ al/at} = 100 \text{ A/} \mu \text{s}$		18	32	nC	
NOTES: <b>1:</b> R <sub>0JA</sub> is deterr the user's board	nined with the device mounted on a 1 in <sup>2</sup> pad 2 oz copper p d design.	ad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\rm 6JC}$ is $\varsigma$	guaranteed	by design whi	e R <sub>0CA</sub> is de	termined by	
	a. 53 °C/W when mounte a 1 in <sup>2</sup> pad of 2 oz co		V when moi m pad of 2				

2: Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0 %. 3. E<sub>AS</sub> of 144 mJ is based on starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 17 A, V<sub>DD</sub> = 27 V, V<sub>GS</sub> = 10 V. ©2010 Fairchild Semiconductor Corporation FDMC7672 Rev.C5

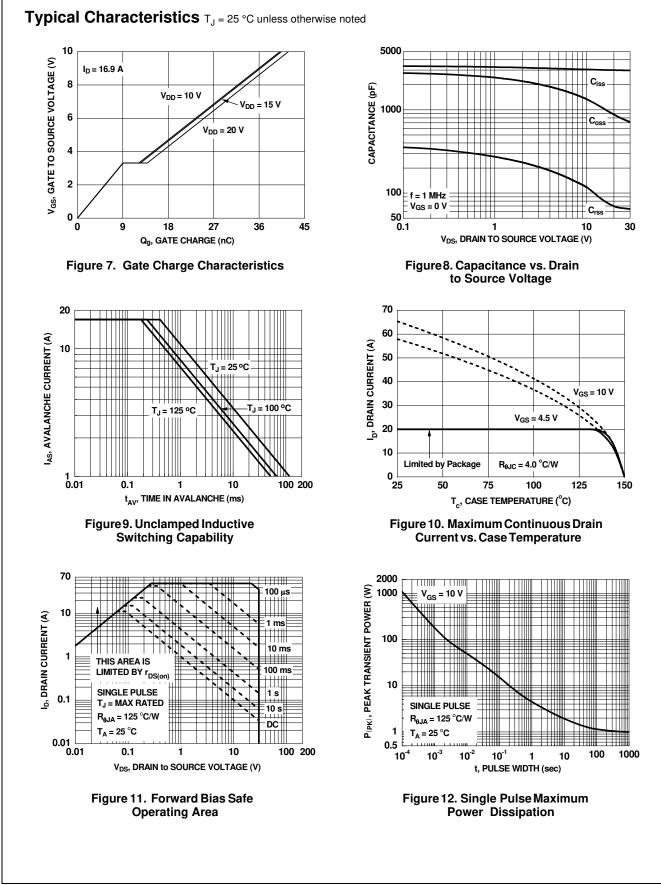
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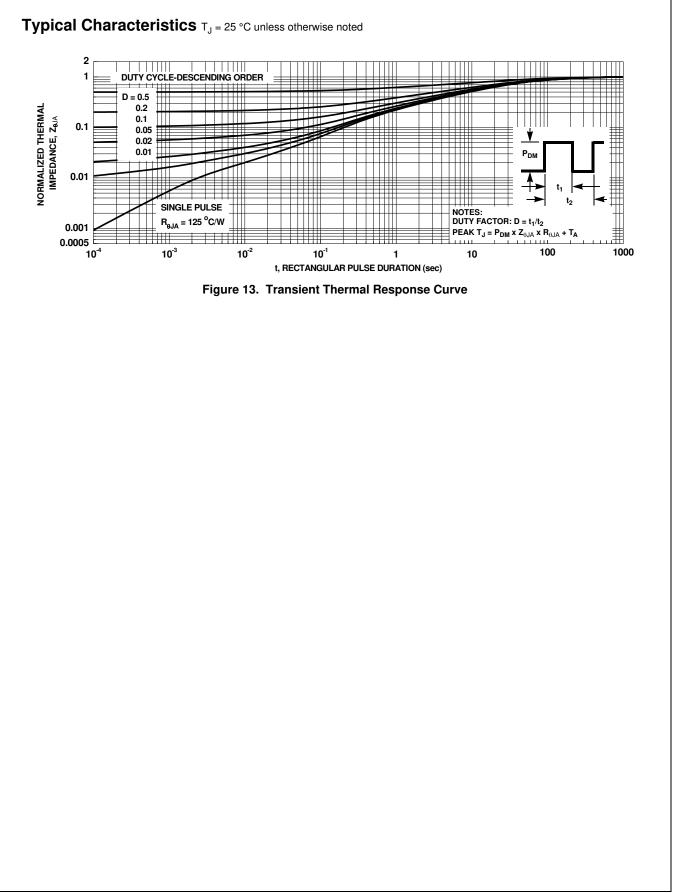
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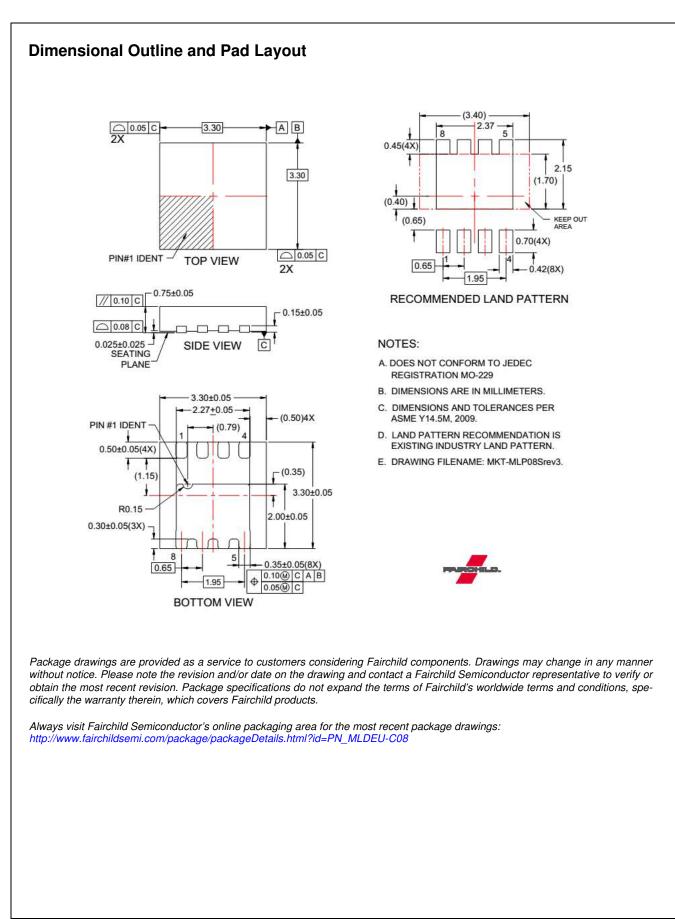
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FDMC7672 N-Channel Power Trench<sup>®</sup> MOSFET





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